



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Shui-Ming Cheng, et al.	§	Docket No.:	24061.149
		§		
Serial No.:	10/722,218	§	Art Unit:	2811
		§		
Filed:	November 25, 2003	§	Examiner:	To Be Determined
		§		
Entitled:	Semiconductor Device Having High	§		
	Drive Current and Method of	§		
	Manufacture Thereof	§		

INFORMATION DISCLOSURE STATEMENT

Commissioner For Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In compliance with the duty of disclosure under 37 CFR §1.56, and in accordance with the practice under 37 CFR §1.97 and §1.98, the Examiner's attention is directed to the documents listed on the enclosed modified Form PTO-1449. No inference should be made that the cited references are in fact material, are in fact prior art, or that no better art exists. A copy of the cited referenced is enclosed.

This Information Disclosure Statement is being filed within three months of the United States filing date or before the mailing date of a first Office Action on the merits. No certification or fee is required (37 CFR §1.97(b)).

The Commissioner is hereby authorized to charge any additional fees which may be required or credit any overpayment to Deposit Account 08-1394.

It is respectfully requested that the above information be considered by the Examiner and that a copy of the enclosed Form PTO-1449 be returned indicating that such information has been considered.

Respectfully submitted,

T. F. Bliss

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Date: 3/18/04

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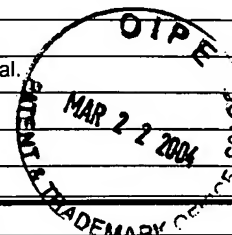
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In place of PTO-1449 Form	U. S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	<i>Complete if Known</i>												
INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(use as many sheets as necessary)</i>		<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 60%;">Application Number</td> <td>10/722,218</td> </tr> <tr> <td>Filing Date</td> <td>November 25, 2003</td> </tr> <tr> <td>Applicant(s)</td> <td>Shui-Ming Cheng, et al.</td> </tr> <tr> <td>Art Unit</td> <td>2811</td> </tr> <tr> <td>Examiner Name</td> <td>TBD</td> </tr> <tr> <td>Attorney Docket Number</td> <td>24061.149</td> </tr> </table>	Application Number	10/722,218	Filing Date	November 25, 2003	Applicant(s)	Shui-Ming Cheng, et al.	Art Unit	2811	Examiner Name	TBD	Attorney Docket Number	24061.149
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SHEET	1	OF 1												



U. S. PATENT DOCUMENTS				
Examiner's Initials	Cite No.	Document Number	Publication Date <small>MM-DD-YYYY</small>	Name of Patentee or Applicant of Cited Document

FOREIGN PATENT DOCUMENTS					
Examiner's Initials	Cite No.	Foreign Patent Document <small>(Country Code - Number - Kind)</small>	Publication Date <small>MM-DD-YYYY</small>	Patentee or Applicant of Cited Document	Translation <small>Y/N</small>

OTHER PRIOR ART		
Examiner's Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article, title of the item, date, page(s), volume-issue number(s), publisher, city/country where published
	AA	SHIMIZU, A., et al., "Local Mechanical-Stress Control (LMC): A New Technique for CMOS-Performance Enhancement", IEEE, 2001, 4 pages.

Examiner Signature	Date Considered
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include a copy of this form with next communication to applicant.